WHAT IS CLAIMED IS:

1. A liquid crystal device comprising: a pair of substrates; a liquid crystal layer provided therebetween; and a sealing material bonding said pair of substrates to each other and enclosing the liquid crystal layer between said pair of substrates,

wherein the sealing material contains a photocurable component and a thermosetting component, the photocurable component has a maximum curing rate in the range of from 60% to 95%, and the thermosetting component has a curing rate in the range of from 60% to 90%.

2. The liquid crystal device according to Claim 1, wherein the sealing material comprises a resin containing the photocurable component and the thermosetting component in the same molecular chain.

3. The liquid crystal device according to Claim 1, wherein the sealing material comprises a resin containing the photocurable component, a resin containing the thermosetting component, and a resin containing the photocurable component and the thermosetting component in the same molecular chain.

4. The liquid crystal device according to Claim 1, wherein the photocurable component comprises an acrylic group and/or a methacrylic group.

5. The liquid crystal device according to Claim 1, wherein the thermosetting component comprises an epoxy group.

6. A method for manufacturing a liquid crystal device having a liquid crystal layer provided between a pair of substrates, the method comprising:

a step of applying an adhesive onto at least one of surfaces of said pair of substrates to form a closed frame shape in a region of the surface thereof;

a step of disposing spacers on at least one of surfaces of said pair of substrates;

a step of dripping liquid crystal onto at least one of surfaces of said pair of substrates after the adhesive and the spacers are disposed;

a step of bonding said pair of substrates to each other after the liquid crystal is dripped; and

a step of curing the adhesive after the bonding is performed,

wherein the adhesive is an uncured material which is formed to a sealing material according to Claim 1 by curing.

7. A method for manufacturing a liquid crystal device having a liquid crystal layer provided between a pair of substrates, the method comprising:

a step of applying an adhesive onto at least one of surfaces of said pair of substrates to form a frame shape provided with a liquid crystal inlet;

a step of disposing spacers on at least one of surfaces of said pair of substrates;

a step of bonding said pair of substrates to each other after the adhesive and the spacers are disposed;

a step of curing the adhesive after the bonding is performed, and

a step of injecting liquid crystal inside the adhesive through the liquid crystal inlet;

wherein the adhesive is an uncured material which is formed to a sealing material according to Claim 1 by curing.

8. The method for manufacturing a liquid crystal device, according to Claim 6, wherein the step of curing the adhesive comprises a light irradiation substep of curing the photocurable component, and the amount of light irradiation in the light irradiation substep is 1,000 to 6,000 mJ/cm^2.

9. The method for manufacturing a liquid crystal device, according to Claim 6, wherein the step of curing the adhesive comprises a heating substep of curing the thermosetting component, and the heating temperature and the heating time in the heating substep are set to 60 to 160°C and 20 to 300 minutes, respectively.

10. An electronic apparatus comprising a liquid crystal device according to Claim 1.